No.: RPC-K-HTS-0002 /8

Date: 2017. 4. 21

Data sheet

FIXED THICK FILM CHIP RESISTORS;
RECTANGULAR TYPE AND ANTI SURGE

Style: RPC16, 20, 32, 35, 50, 63

AEC-Q200 qualified

RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature: +5°C ~ +35°C Relative humidity: 25% ~ 75%

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- •If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

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Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND ANTI SURGE

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1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & anti surge, style of RPC16, 20, 32, 35, 50, 63.

1.2 Applicable documents

JIS C 5201-1: 2011, JIS C 5201-8: 2014, JIS C 5201-8-1: 2014 IEC60115-1: 2008, IEC60115-8: 2014, IEC60115-8-1: 2014 EIAJ RC-2134C-2010

2. Classification

Type designation shall be the following form.

(Example)

1 Fixed thick film chip resistors; rectangular type and anti surge

— Style

2 Size

3 Rated resistance

475 E24 Series, 3 digit, Ex. 475--> 4.7MΩ,

4 Tolerance on rated resistance

| J | ±5% |
|---|------|
| K | ±10% |
| M | ±20% |

5 Packaging form

| 99 | | |
|----|----------------------|--|
| В | Bulk (loose package) | |
| TP | Paper taping | |
| TE | Embossed taping | |

3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1(2)

| Style | Rated dissipation (W) | Temperature coefficient of resistance (10 ⁻⁶ /°C) | Rated resistance range(Ω) | Preferred number series for resistors | Tolerance on rated resistance |
|-------|-----------------------|--|---------------------------|---------------------------------------|-------------------------------|
| RPC16 | 0.25 | ±100 | 10~1M | E24 | J(±5%) |
| 0.0 | 0.20 | ±200 | 1.0~9.1 | | 3(=370) |
| | | ±200 | 1.1M~22M | | |
| RPC20 | 0.25 | ±100 | 1.0~1M | E24 | J(±5%), K(±10%), M(±20%) |
| | | ±200 | 0.27~0.91 | | |
| | | ±200 | 1.1M~22M | | |
| RPC32 | 0.33 | ±100 | 1.0~1M | E24 | J(±5%), K(±10%), M(±20%) |
| | | ±200 | 0.27~0.91 | | |
| | | ±200 | 1.1M~22M | | |
| RPC35 | 0.5 | ±100 | 1.0~1M | E24 | J(±5%), K(±10%), M(±20%) |
| | | ±200 | 0.27~0.91 | | |
| | | ±200 | 1.1M~22M | | |
| RPC50 | 0.75 | ±100 | 1.0~1M | E24 | J(±5%), K(±10%), M(±20%) |
| | | ±200 | 0.27~0.91 | | |
| | | ±200 | 1.1M~22M | | |
| RPC63 | 1.0 | ±100 | 1.0~1M | E24 | J(±5%), K(±10%), M(±20%) |
| | | ±200 | 0.27~0.91 | | |

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Table-1(2)

| Style | Limiting element voltage (V) | Isolation voltage (V) | Category temperature range (°C) |
|-------|------------------------------|--------------------------|---------------------------------|
| RPC16 | 150 | 150 | |
| RPC20 | 150 | 500 | 55 .455 |
| RPC32 | | | |
| RPC35 | 200 | | _55~ + 155 |
| RPC50 | 200 | | |
| RPC63 | | | |

3.2 Climatic category

55/155/56 Lower category temperature -55 °C

Upper category temperature +155 °C

Duration of the damp heat, steady state test 56days

3.3 Stability class

5% Limits for change of resistance:

 $\begin{array}{ll} -\text{for long-term tests} & \pm (5\% + 0.1 \Omega) \\ -\text{for short-term tests} & \pm (1\% + 0.05 \Omega) \end{array}$

3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

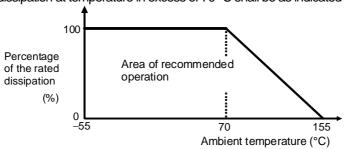


Figure-1 Derating curve

3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{\begin{array}{c} P \cdot R \\ P : Rated \ voltage \ (V) \\ R : Rated \ dissipation \ (W) \\ R : Rated \ resistance \ (\Omega) \\ \end{array}}$$

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table–2.

Table-2

| Symbol | Packaging form | | Standard packaging quantity / units | Application |
|--------|---|------------------------|--|---------------------------|
| В | Bulk (loose package) | | 1,000 pcs. | RPC16, 20, 32, 35, 50, 63 |
| TP | Paper taping | 8mm width, 4mm pitches | 5,000 pcs. | RPC16, 20, 32 |
| TE | Embassed tening 8mm width, 4mm pitches | | RPC35 | |
| TE | Embossed taping 12mm width, 4mm pitches | 4,000 pcs. | RPC50, 63 | |

I Init: mm

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5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

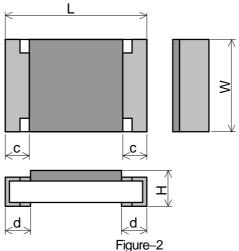


Figure-2 Table-3

| | labic-3 | | | | Offic. ITHIT |
|-------|----------------|-----------------------|-----------------|----------------|---------------|
| Style | Ĺ | W | Н | С | d |
| RPC16 | 1.6±0.1 | $0.8^{+0.15}_{-0.05}$ | 0.45±0.10 | 0.3±0.2 | 0.3±0.1 |
| RPC20 | 2.0 ± 0.1 | 1.25 ± 0.10 | 0.55 + 0.40 | | 0.4 ± 0.2 |
| RPC32 | 3.1 ± 0.1 | 1.6 ± 0.15 | 0.55 ± 0.10 | 0.3 ± 0.2 | 0.5 ± 0.25 |
| RPC35 | 3.1 ± 0.15 | 2.5 ± 0.15 | | | 0.5 ± 0.25 |
| RPC50 | 5.0 ± 0.15 | 2.5 ± 0.15 | 0.55 ± 0.15 | 0.3 ± 0.15 | 0.6 ± 0.2 |
| RPC63 | 6.3 ± 0.15 | 3.2 ± 0.15 | | 0.5 ± 0.15 | 0.0 ± 0.2 |

5.2 Net weight (Reference)

| Style | Net weight(mg) |
|-------|----------------|
| RPC16 | 2 |
| RPC20 | 5 |
| RPC32 | 9 |
| RPC35 | 16 |
| RPC50 | 25 |
| RPC63 | 40 |

6. Marking

The Rated resistance shall be marked in 3 digits (E24) and marked on over coat side.

| Marking example | Contents | Application |
|-----------------|--|-------------|
| 123 | $12\times10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$ | E24 |
| 2R2 | 2.2 [Ω] | E24 |

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

| No. | Test items | Condition of test (JIS C 5201–1) | Performance requirements |
|-----|-------------------------------|--|---------------------------------------|
| 1 | Visual examination | Sub-clause 4.4.1 | As in 4.4.1 |
| - | | Checked by visual examination. | The marking shall be legible, as |
| | | Choshed by Medal Chairmidaechii | checked by visual examination. |
| 2 | Dimension | Sub-clause 4.4.2 | As specified in Table-3 of this |
| | | | specification. |
| | Resistance | Sub-clause 4.5 | As in 4.5.2 |
| | | | The resistance value shall |
| | | | correspond with the rated resistance |
| | | | taking into account the specified |
| | | | tolerance. |
| 3 | Voltage proof | Sub-clause 4.7 | No board day on official and |
| | | Method: 4.6.1.4(See Figure–5) | No breakdown or flash over |
| | | Test voltage: Alternating voltage with a peak | |
| | | value of 1.42 times the insulation | |
| | | voltage. Duration: 60 s ± 5 s | |
| | | Insulation resistance | R≥1GΩ |
| | | Test voltage: Insulation voltage | |
| | | Duration: 1 min. | |
| 4 | Solderability | Sub-clause 4.17 | As in 4.17.4.5 |
| | - | Without ageing | The terminations shall be covered |
| | | Flux: The resistors shall be immersed in a | with a smooth and bright solder |
| | | non-activated soldering flux for 2s. | coating. |
| | | Bath temperature: 235 °C ± 5 °C | |
| | | Immersion time: 2 s ± 0.5 s | |
| 5 | Mounting | Sub-clause 4.31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure–3 | |
| | Overload | Sub-clause 4.13 | |
| | (in the mounted state) | The applied voltage shall be 2.5 times the rated | |
| | (iii a io iiio ai io a dialo) | voltage or twice the limiting element voltage, whichever is the less severe. | |
| | | Duration: 2 s | |
| | | Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | Solvent resistance of the | Sub-clause 4.30 | Legible marking |
| | marking | Solvent: 2-propanol | |
| | | Solvent temperature: 23 °C ± 5 °C | |
| | | Method 1 | |
| | | Rubbing material: cotton wool | |
| | | Without recovery | |

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Table-4(2)

| | | 1abic 4(2) | |
|----|------------------------------|--|---|
| No | Test items | Condition of test (JIS C 5201–1) | Performance requirements |
| 6 | Mounting | Sub-clause 4.31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure-4 | |
| | Bound strength of the end | Sub-clause 4.33 | |
| | face plating | Bent value: 3 mm (3225 size max.) | |
| | | 1 mm (5025 size min.) | |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | Final measurements | Sub-clause 4.33.6 | No visible damage |
| | | Visual examination | |
| 7 | Resistance to soldering heat | Sub-clause 4.18 | |
| 1 | | Solder temperature: 260 °C ± 5 °C | |
| | | Immersion time: $10 \text{ s} \pm 0.5 \text{ s}$ | |
| | | Visual examination | As in 4.18.3.4 |
| | | | No sign of damage such as cracks. |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | Component solvent | Sub-clause 4.29 | |
| | resistance | Solvent: 2-propanol | |
| | | Solvent temperature: 23 °C ± 5 °C | |
| | | Method 2 | |
| | | Recovery: 48 h | |
| | | Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| 8 | Mounting | Sub-clause 4.31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure–3 | |
| | Adhesion | Sub-clause 4.32 | |
| | | Force: 5 N | |
| | | Duration: 10 s ± 1 s | |
| | Danid shangs towns rature | Visual examination | No visible demage |
| | Rapid change temperature | Sub-clause 4.19 | No visible damage |
| | | Lower category temperature:-55 °C | |
| | | Upper category temperature:+155 °C | |
| | | Duration of exposure at each temperature: | |
| | | 30 min. | |
| | | Number of cycles: 5 cycles. | No visible damage |
| | | Visual examination | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | | Resistance | $\triangle I \setminus \triangle \pm (1.70 \pm 0.0022)$ |

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Table-4(3)

| No | Test items | Condition of test (JIS C 5201–1) | Performance requirements |
|----|--------------------|--|--|
| 9 | Climatic sequence | Sub-clause 4.23 | |
| | -Dry heat | Sub-clause 4.23.2 | |
| | • | Test temperature: +155 °C | |
| | | Duration: 16 h | |
| | -Damp heat, cycle | Sub-clause 4.23.3 | |
| | (12+12hour cycle) | Test method: 2 | |
| | First cycle | Test temperature: 55 °C | |
| | | [Severity(2)] | |
| | | Sub-clause 4.23.4 | |
| | -Cold | Test temperature –55 °C | |
| | | Duration: 2h | |
| | | Sub-clause 4.23.6 | |
| | –Damp heat, cycle | Test method: 2 | |
| | (12+12hour cycle) | Test temperature: 55 °C | |
| | Remaining cycle | [Severity (2)] | |
| | | Number of cycles: 5 cycles | |
| | | Sub-clause 4.23.7 | |
| | –D.C. load | The applied voltage shall be the rated voltage | |
| | | or the limiting element voltage whichever is the | |
| | | smaller. | |
| | | Duration: 1 min. | No visible damage |
| | | Visual examination | $\Delta R \le \pm (5\% + 0.1\Omega)$ |
| | | Resistance | ΔI\ ≤ ± (3/0+0.122) |
| 10 | Mounting | Sub-clause 4.31 | |
| | | Substrate material: Epoxide woven glass | |
| | | (RPC63 may use Alumina substrate.) | |
| | | Test substrate: Figure–3 | |
| | Endurance at 70 °C | Sub-clause 4.25.1 | |
| | | Ambient temperature: 70 °C ± 2 °C | |
| | | Duration: 1000 h | |
| | | The voltage shall be applied in cycles of 1.5 h | |
| | | on and 0.5 h. | |
| | | The applied voltage shall be the rated voltage | |
| | | or the limiting element voltage whichever is the | |
| | | smaller. | |
| | | Examination at 48 h, 500 h and | |
| | | 1000 h: Visual examination | No visible damage |
| | | | $\Delta R \le \pm (5\% + 0.1\Omega)$ |
| | | Resistance | $\triangle I \setminus \triangle \perp (O / 0 T O, 1 2 2)$ |

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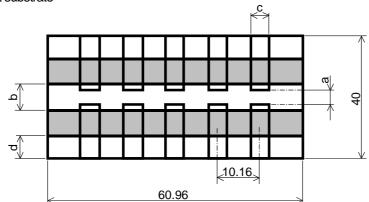
Table 4(4)

| | | 1abi c 4(4) | |
|----|------------------------------|---|---------------------------------------|
| No | Test items | Condition of test (JIS C 5201–1) | Performance requirements |
| 11 | Mounting | Sub-clause 4.31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure–3 | |
| | Variation of resistance with | Sub-clause 4.8 | As in Table–1 |
| | temperature | _55 °C / +20 °C | |
| | | +20 °C / +155°C | |
| 12 | Mounting | Sub-clause 4.31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure–3 | |
| | Damp heat, steady state | Sub-clause 4.24 | |
| | | Ambient temperature: 40 °C ± 2 °C | |
| | | Relative humidity: 93^{+2}_{-3} % | |
| | | a) 1st group: without voltage applied. | |
| | | b) 2nd group: The d. c. voltage shall be applied | |
| | | continuously. | |
| | | The voltage shall be accordance with | |
| | | Sub-clause 4.24.2.1 b). without polarizing | |
| | | voltage [4.24.2.1, c)] | No visible damage |
| | | Visual examination | Legible marking |
| | | Desistance | $\Delta R \le \pm (5\% + 0.1\Omega)$ |
| 40 | Dimensions (detail) | Resistance | , |
| 13 | Dimensions (detail) | Sub-clause 4.4.3 | As in Table–3 |
| | Mounting | Sub players 4.24 | |
| | iviouriting | Sub-clause 4.31 Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure–3 | |
| | Endurance at upper category | Sub-clause 4.25.3 | |
| | temperature | Ambient temperature:155 °C ± 2 °C | |
| | , | Duration: 1000 h | |
| | | Examination at 48 h, 500 h and | |
| | | 1000 h: | |
| | | Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (5\% + 0.1\Omega)$ |
| | | 1 | · · · · · · · · · · · · · · · · · · · |

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND ANTI SURGE

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8. Test substrate

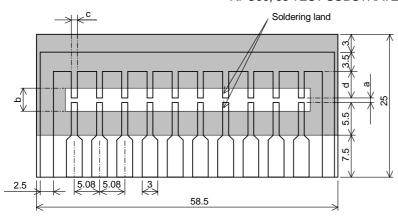


Unit: mm

| | :Solder | resist |
|--|---------|--------|
|--|---------|--------|

| Style | а | b | С | d |
|-------|-----|-----|-----|-----|
| RPC50 | 4.0 | 7.5 | 2.0 | 7.5 |
| RPC63 | 5.0 | 9.0 | 4.5 | 7.5 |

RPC50, 63 TEST SUBSTRATE

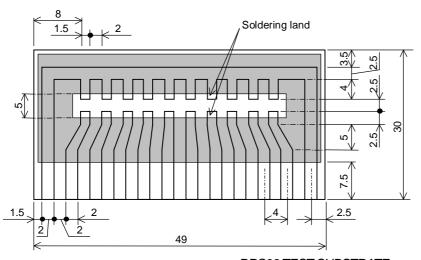


Unit: mm

| :Copper | clad |
|---------|------|
| .Ooppoi | Oiuc |

| Style | а | b | С | d |
|-------|-----|-----|-----|-----|
| RPC20 | 1.2 | 4.0 | 1.5 | 4.3 |
| RPC35 | 2.2 | 5.0 | 2.9 | 3.3 |

RPC20, 35 TEST SUBSTRATE



Unit: mm

:Copper clad

RPC32 TEST SUBSTRATE

Figure-3(1)

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

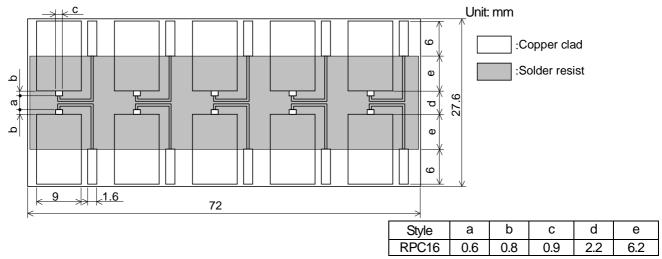
2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

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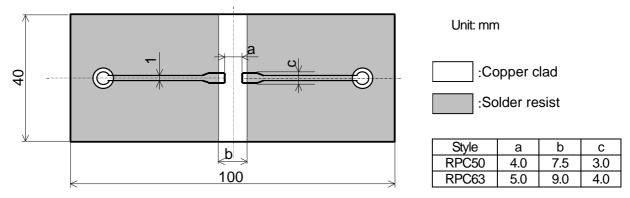
RPC16 TEST SUBSTRATE

Figure-3(2)

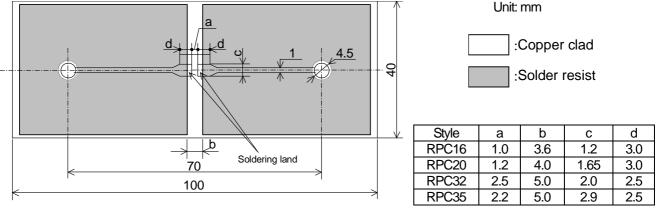
Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.07mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.



RPC50, 63 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE



Remark 1). Material: Epoxide woven glass

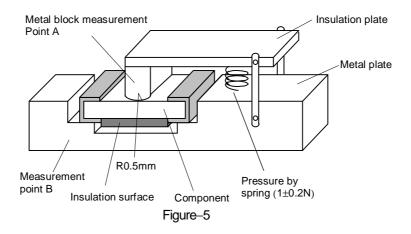
Thickness: 1.6mm Thickness of copper clad: 0.035mm

RPC16,20,32,35 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

Figure 4

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9. Taping

- 9.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 9.2 Taping dimensions
- 9.2.1 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-5.

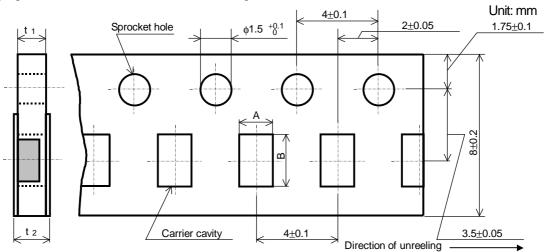


Figure-6

| <u> </u> | | | | |
|----------|-------------|---------------|---------------|------------|
| Table-5 | | | | Unit: mm |
| Style | Α | В | t 1 | t 2 |
| RPC16 | 1.15 ± 0.15 | 1.9 ± 0.2 | 0.6 ± 0.1 | 0.8max. |
| RPC20 | 1.65±0.15 | 2.5±0.2 | 0.8±0.1 | 1.0max. |
| RPC32 | 2.00±0.15 | 3.6±0.2 | 0.0±0.1 | 1.0Hax. |

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9.2.2 Embossed taping dimensions shall be in accordance with Figure-7 and Table-6.

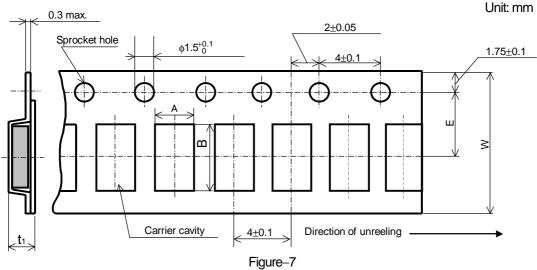
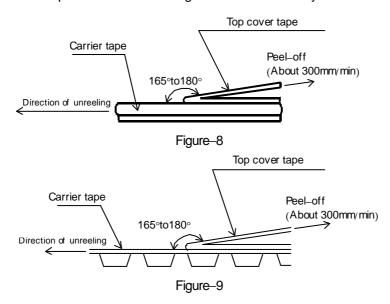


Table-6 Unit: mm Style В 2.85 ± 0.2 RPC35 3.5 ± 0.2 8.0 ± 0.3 3.5 ± 0.05 1.0 ± 0.2 RPC50 3.1 ± 0.2 5.5 ± 0.2 12.0±0.3 5.5±0.05 1.1±0.15 RPC63 6.9±0.2 3.6 ± 0.2

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RPC16, 20, 32: Figure–8, RPC35, 50, 63: Figure–9.
- 6). When the tape is bent with the minimum radius for RPC16, 20, 32, 35: 25 mm, or RPC50, 63: 30 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



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9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–10 and Table–7. Plastic reel (Based on EIAJ ET–7200C)

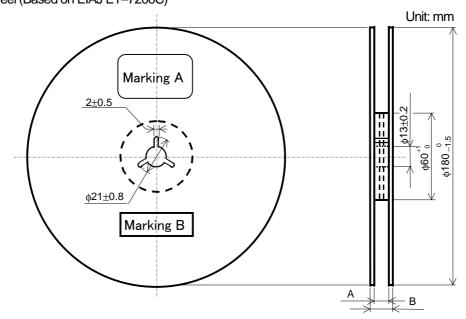
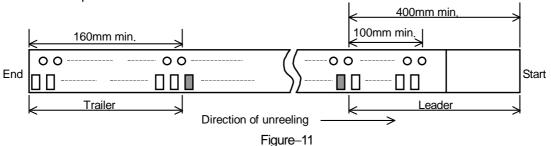


Figure-10

| | Table–7 | | |
|----------------|--------------------|----------|-------------------|
| Style | Α | В | Note |
| RPC16,20,32,35 | 9 +1.0 | 11.4±1.0 | Injection molding |
| | | 13±1.0 | Vacuum forming |
| RPC50,63 | 13 ^{+1.0} | 17±1.0 | Vacuum forming |

Note: Marking label shall be marked on a place of Marking A or two place of Marking A and B.

9.4 Leader and trailer tape.



10. Marking on package

The label of a minimum package shall be legibly marked with follows.

10.1 Marking A

- (1) Classification (Style, Rated resistance, Tolerance on rated resistance, Packaging form)
- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 10.2 Marking B (KAMAYA Control label)

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